

FORM PTO-1449

US DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICEAtty. Docket No.  
**85019LMB**  
Customer No. 01333

Serial No.

**10/633,901**If AFTER the later date of the first Office Action  
or 3 months from filing, use only with Rule 97(E)  
Certificate or Fee

Applicant:

**Yuanqiao Rao, et al**

## LIST OF ART CITED BY APPLICANT

(Use several sheets if necessary)

Filing Date

**10/633,901****10/04/03**

Group

**1700**

## U.S. PATENT DOCUMENTS

Examiner Initial*	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<b>ku</b>	2,173,480	09-19-1939	Jung			
<b>ll</b>	2,259,009	10-14-1941	Talbot			
	2,331,746	10-12-1943	Talbot			
	2,536,764	01-02-1951	Moulton			
	2,706,686	04-19-1955	Hilborn			
	2,798,004	07-02-1957	Weigel			
	3,113,867	12-10-1963	Van Norman et al.			
	3,190,197	06-22-1965	Pinder			
	3,397,980	08-20-1968	Stone			
	3,415,670	12-10-1968	McDonald			
	3,443,946	05-13-1969	Grabhofer et al.			
	3,502,501	03-24-1970	Burczyk et al.			
	3,617,354	11-02-1971	Carnahan et al.			
	3,697,277	10-10-1972	King			
	3,733,293	05-15-1973	Gallagher et al.			
	4,092,173	05-30-1978	Novak et al.			
	5,552,469	09-03-1996	Beall et al.			
	5,578,672	11-26-1996	Beall et al.			
	5,683,862	11-04-1997	Majumdar et al.			
	5,753,426	05-19-1998	Nair et al.			
	5,866,287	02-02-1999	Christian et al.			
	5,891,611	04-06-1999	Majumdar et al.			
<b>ku</b>	6,060,230	05-09-2000	Christian et al.			

## FOREIGN PATENT DOCUMENTS

Examiner Initial*	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
<b>ku</b>	0 780 340 B1	03-20-2002	EP				
<b>ku</b>	93/11190	06-10-1993	WO				X
							X

## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

EXAMINER	DATE CONSIDERED	
	<b>11/22/03</b>	
	Co-pending USSN <b>85018)</b>	<b>Rao et al. Imaging Material With Improved Scratch Resistance (D-</b>

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.